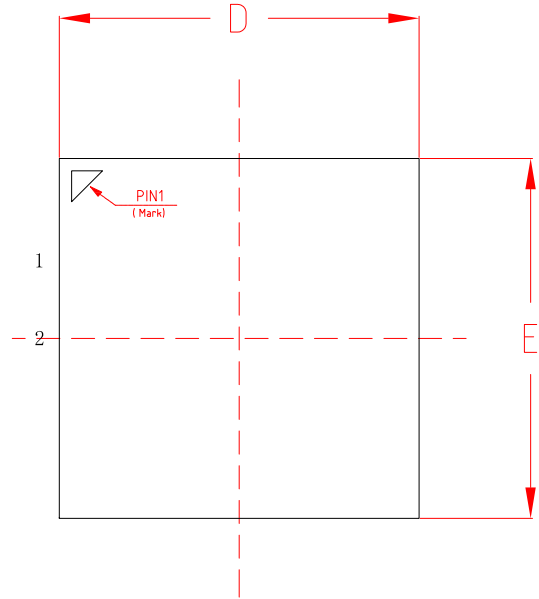


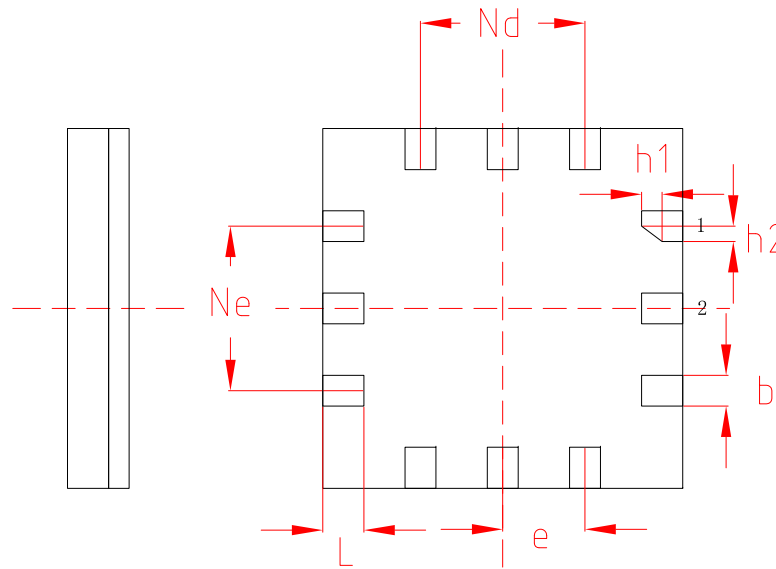
TOP VIEW

正视图



SIDE VIEW

侧视图



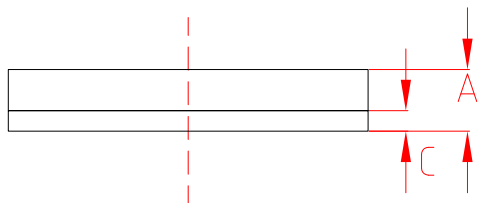
BOTTOM VIEW



背视图

机械尺寸/mm Dimensions			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	0.500	0.600	0.700
c	0.160	0.200	0.240
b	0.225	0.300	0.375
D	3.400	3.500	3.600
E	3.400	3.500	3.600
e	0.800 BSC		
L	0.325	0.400	0.475
h1	0.125	0.200	0.275
h2	0.075	0.150	0.225
Ne	1.600BSC		
Nd	1.600BSC		

SIDE VIEW

侧视图



 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD		制图: Draw	Lisa 2022. 12. 16
图号 Drawing NO.	HY-POD-012035035001		制图核查: Drawing review
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA12L (3.5×3.5×0.6-P0.80)		审核: Checker
幅图 size	页数 page	单位 unit	比例 scale
A4	1	mm	1:1
			视图 view
			 核准: Approved